

# Half-Bridge Gate Driver

#### **Features**

- Floating high-side driver in bootstrap operation to 600V
- Drives two N-channel MOSFETs or IGBTs in a half bridge configuration
- Designed for enhanced performance in noisy motor applications
- 290mA source/600mA sink output current capability
- Outputs tolerant to negative transients
- Internal dead time of 420ns to protect MOSFETs
- Wide low side gate driver supply voltage: 10V to 20V
- Logic input (HIN and LIN\*) 3.3V capability
- Schmitt triggered logic inputs
- Undervoltage lockout for V<sub>cc</sub> (logic and low side supply)
- Extended temperature range: -40°C to +125°C

### **Description**

The TF2103M is a high voltage, high speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. TF Semiconductors's high voltage process enables the TF2103M high side to switch to 600V in a bootstrap operation.

The TF2103M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. TF2103M has a fixed internal deadtime of 420ns (typical).

The TF2103M is offered in a SOIC-8(N) and PDIP-8 package and operates over an extended -40  $^{\circ}$ C to +125  $^{\circ}$ C temperature range.

### **Applications**

- Motor Controls
- DC-DC Converters
- AC-DC Inverters
- Motor Drives

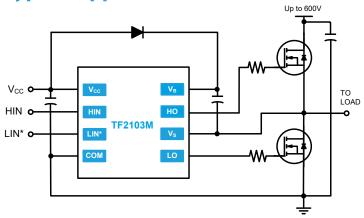






PDIP-8

### **Typical Application**



### **Ordering Information**

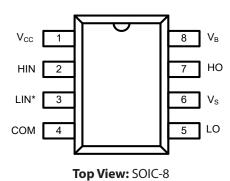
Year Year Week Week

| PART NUMBER | PACKAGE   | PACK / Qty | MARK                          |  |
|-------------|-----------|------------|-------------------------------|--|
| TF2103M-3AS | PDIP-8    | Tube / 50  | YYWW<br>⟨TF⟩TF2103M<br>Lot ID |  |
| TF2103M-TAU | SOIC-8(N) | Tube / 100 | YYWW                          |  |
| TF2103M-TAH | SOIC-8(N) | T&R / 2500 | TF>TF2103M<br>Lot ID          |  |

www.tfsemi.com Rev 1.0





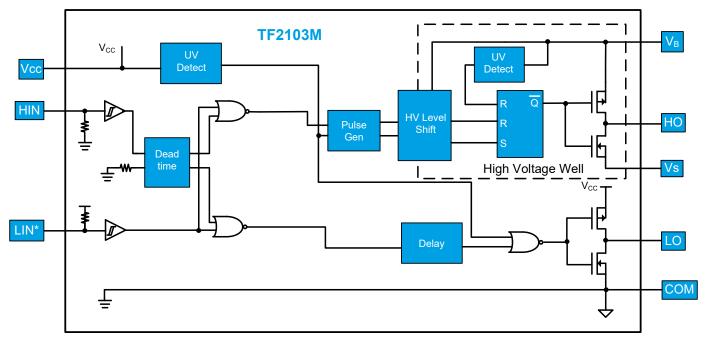


TF2103M

## **Pin Descriptions**

| PIN NAME        | PIN NUMBER | PIN DESCRIPTION  |
|-----------------|------------|--|
| V <sub>cc</sub> | 1          | Logic and low side supply  |
| HIN             | 2          | Logic input for high-side gate driver output in phase with HO    |
| LIN*            | 3          | Logic input for low-side gate driver output out of phase with LO |
| COM             | 4          | Low-side and logic return  |
| LO              | 5          | Low-side gate drive output                                       |
| V <sub>s</sub>  | 6          | High-side floating supply return                                 |
| НО              | 7          | High-side gate drive output                                      |
| V <sub>B</sub>  | 8          | High-side floating supply  |

# **Functional Block Diagram**



Dec 2022 2

3



#### **Revision History**

| Rev. | Change        | Owner     | Date      |
|------|---------------|-----------|-----------|
| 1.0  | First release | D. Walton | 12-7-2022 |
|      |               |           |           |

for additional information contact: info@tfsemiconductors.com

### **Important Notice**

TF Semiconductor Solutions (TFSS) PRODUCTS ARE NEITHER DESIGNED NOR INTENDED FOR USE IN MILITARY AND/OR AEROSPACE, AUTOMOTIVE OR MEDICAL DEVICES OR SYSTEMS UNLESS THE SPECIFIC TFSS PRODUCTS ARE SPECIFICALLY DESIGNATED BY TFSS FOR SUCH USE. BUYERS ACKNOWLEDGE AND AGREE THAT ANY SUCH USE OF TFSS PRODUCTS WHICH TFSS HAS NOT DESIGNATED FOR USE IN MILITARY AND/OR AEROSPACE, AUTOMOTIVE OR MEDICAL DEVICES OR SYSTEMS IS SOLELY AT THE BUYER'S RISK.

TFSS assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using TFSS products.

Resale of TFSS products or services with statements different from or beyond the parameters stated by TFSS for that product or service voids all express and any implied warranties for the associated TFSS product or service. TFSS is not responsible or liable for any such statements.

©2022 TFSS. All Rights Reserved. Information and data in this document are owned by TFSS wholly and may not be edited, reproduced, or redistributed in any way without the express written consent from TFSS.

For additional information please contact support@tfsemi.com or visit www.tfsemi.com

Dec 2022